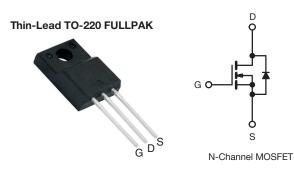
## SiHA12N60E

**Vishay Siliconix** 



## **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.38		
Q <sub>g</sub> max. (nC)	58			
Q <sub>gs</sub> (nC)	6			
Q <sub>gd</sub> (nC)	13			
Configuration	Single			



### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer
  - Adaptors
  - Televisions
  - Game console
- Computing
  - Adaptors
  - ATX power supply

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA12N60E-E3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unless	s otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	600	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	V	
Continuous Drain Current (T <sub>1</sub> = 150 °C) $^{\circ}$	V <sub>GS</sub> at 10 V	<sub>C</sub> = 25 °C c = 100 °C	1	12		
Continuous Drain Current (1) = 150°C)°	V <sub>GS</sub> at 10 V T <sub>C</sub>	c = 100 °C	I <sub>D</sub>	7.8	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	27		
Linear Derating Factor				0.26	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	117	mJ		
Maximum Power Dissipation			PD	33	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope T <sub>J</sub> = 125 °C		dV/dt	70			
Reverse Diode dV/dt d			5	V/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s	3		300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 11.6 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 4.5 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

e. Limited by maximum junction temperature.

COMPLIANT



PARAMETER	SYMBOL	TYP.	MAX	MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 65 - 3.8			°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C_{,1}$	unless otherw	ise noted)						
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static					1			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I <sub>D</sub> = 1 mA	-	0.71	-	V/°C	
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V	
			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 V$		-	-	± 1	μA	
Zava Osta Malta na Ducia Osta			= 600 V, V <sub>GS</sub> = 0 V	-	-	1	- μA	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6 A	-	0.32	0.38	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 8 A		-	3.8	-	S	
Dynamic				•	*	•	•	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$		-	937	-	pF	
Output Capacitance	C <sub>oss</sub>			-	53	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	5	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	41	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	136	-		
Total Gate Charge	Qg			-	29	58		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 6 A, V <sub>DS</sub> = 480 V		-	6	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>			-	13	-	1	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 480 \text{ V}, \text{ I}_D = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$		-	14	28		
Rise Time	t <sub>r</sub>			-	19	38	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	35	70		
Fall Time	t <sub>f</sub>			-	19	38		
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	1.1	-	Ω	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	48	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 6 A, V <sub>GS</sub> = 0 V	-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>			-	350	-	ns	
Reverse Recovery Charge	Q <sub>rr</sub>		5 °C, $I_F = I_S = 6 A$ ,	-	4	-	μC	
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	19	1	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## SiHA12N60E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

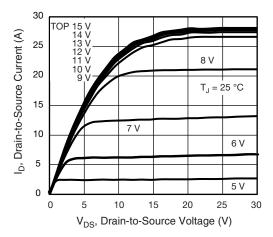


Fig. 1 - Typical Output Characteristics

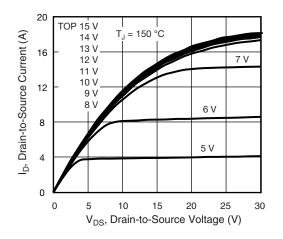
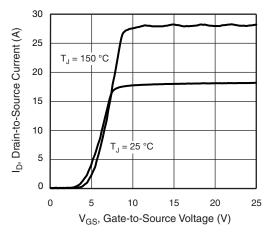


Fig. 2 - Typical Output Characteristics





3 6 On Resistance (Normalized) 2.5 R<sub>DS(on)</sub>, Drain-to-Source 2 1.5 1 10 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

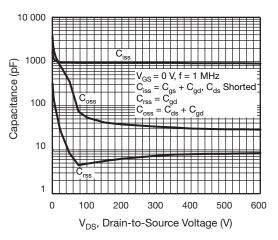


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

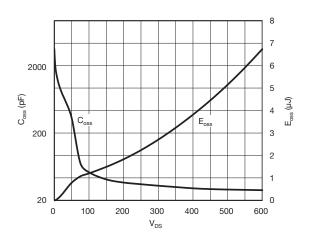


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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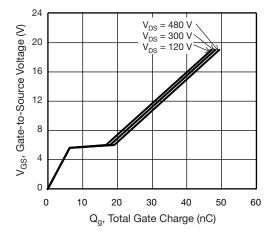


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

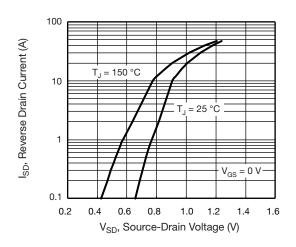


Fig. 8 - Typical Source-Drain Diode Forward Voltage

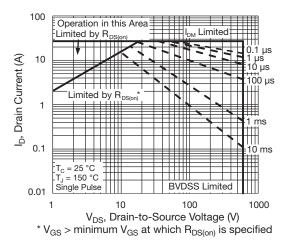


Fig. 9 - Maximum Safe Operating Area

Fig. 10 - Maximum Drain Current vs. Case Temperature

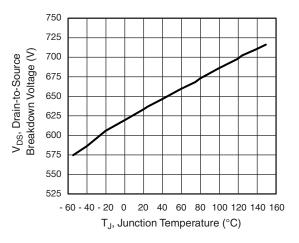


Fig. 11 - Temperature vs. Drain-to-Source Voltage

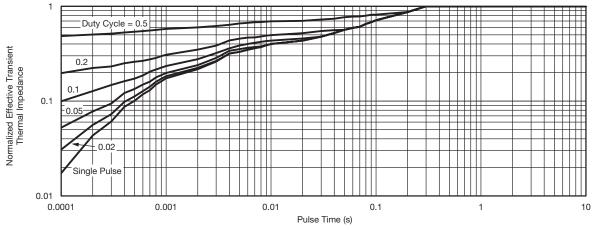
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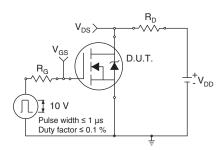


Fig. 13 - Switching Time Test Circuit

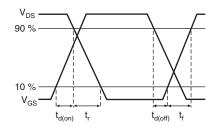


Fig. 14 - Switching Time Waveforms

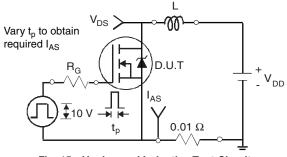


Fig. 15 - Unclamped Inductive Test Circuit

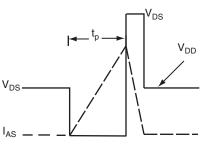


Fig. 16 - Unclamped Inductive Waveforms

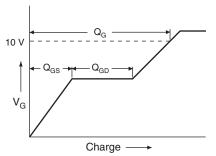


Fig. 17 - Basic Gate Charge Waveform

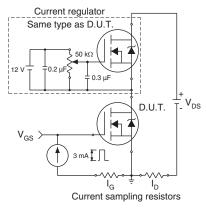


Fig. 18 - Gate Charge Test Circuit

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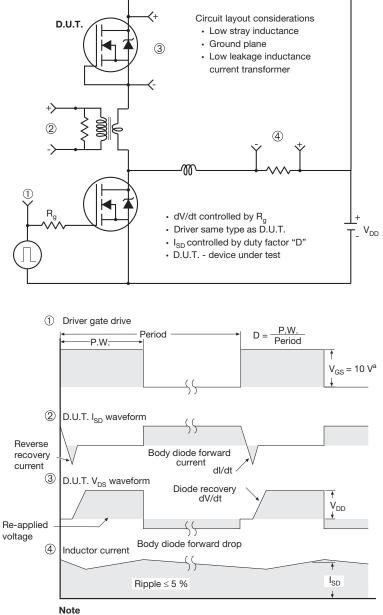
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

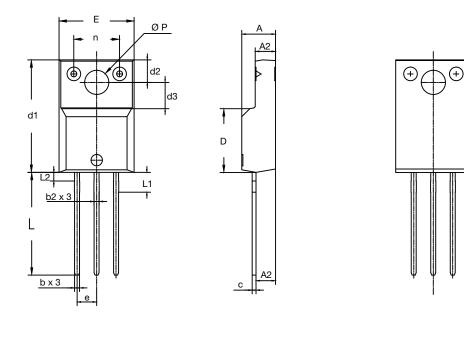
Fig. 19 - For N-Channel

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## **TO-220 FULLPAK Thin Lead**





	DIMENSIONS					
SYMBOL	MILLIN	IETERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.50	2.70	0.098	0.106		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
с	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.40	3.60	0.134	0.142		
E	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	2.50	2.80	0.098	0.110		
L2	-	1.20	-	0.047		
n	6.05	6.15	0.238	0.242		
ØP	3.00	3.40	0.118	0.134		

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